



1.5A SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIER

Product Summary (@T_A = +25°C)

Description and Applications

and telecommunication applications.

V _{RRM} (V)	I _O (A)	V _F (V)	Ι _R (μΑ)
1000	1.5	1.1	5

Suitable for AC to DC bridge full wave rectification for SMPS, LED

lighting, adapter, battery charger, home appliances, office equipment,

Features and Benefits

- Glass Passivated Die Construction
- Miniature Package Saves Space on PC Boards
- High Current Capability
- Ideal for SMT Manufacturing
- Low Forward Voltage Drop
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

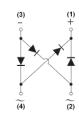
- Case: SOPA-4
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 ⁽²⁾
- Polarity: As Marked on Body
- Weight: 0.10 grams (Approximate)



Top View



Pin Diagram



Internal Schematic

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
ABS10B-13	Commercial	SOPA-4	5,000/Tape & Reel

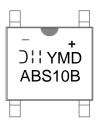
Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



ABS10B = Product Type Marking Code = Manufacturers' Code Marking

YMD = Date Code Marking

- Y = Last Digit of Year (ex: 7 = 2017)
- M = See Month/Code Table Below

D = Day 1 to 9 = 1 to 9; Day 10 to 31 = A to V

Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. Fo

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	1000	V
RMS Reverse Voltage	V _{R(RMS)}	700	V
Average Rectified Output Current (Note 6) @ T _A = +40°C	lo	1.5	А
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	50	A
I ² t Rating for Fusing (1ms < t < 8.3ms)	l ² t	10.4	A ² S

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Ambient (Note 6) (Per Element)	$R_{\theta JA}$	62.5	°C/W
Typical Thermal Resistance, Junction to Lead (Per Element)	R _{0JL}	25	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

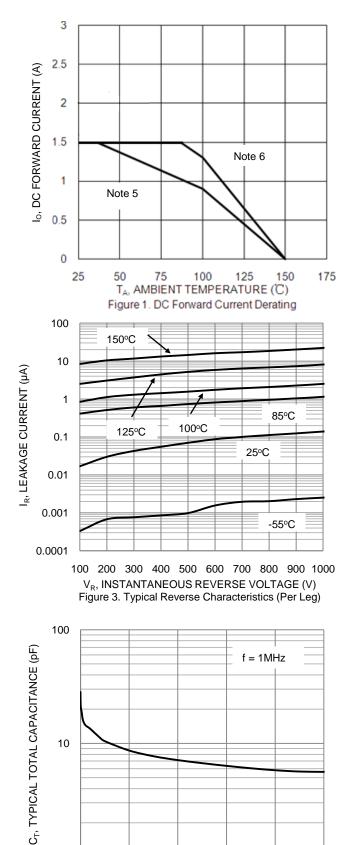
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	1,000	_	_	V	I _R = 5μA
Forward Voltage (Per Element)	VF	_	_	1.1	V	I _F = 1.5A, T _A = +25°C
Leakage Current (Note 7) (Per Element)	I _R	_	_	5 500	μA	$V_R = 1,000V, T_A = +25^{\circ}C$ $V_R = 1,000V, T_A = +125^{\circ}C$
Total Capacitance (Per Element)	CT	—	17	_	pF	$V_{R} = 4V, f = 1.0MHz$

Notes:

Device mounted on FR-4 substrate, 1"*1", 2oz, single-sided, PC boards with 0.15"*0.26" copper pad.
Device mounted on FR-4 substrate, 1"*1", 2oz, single-sided, PC boards with 0.56"*0.73" copper pad.
Short duration pulse test used to minimize self-heating effect.



NEW PRODUCT



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V_R, REVERSE VOLTAGE (V) Figure 5. Typical Total Capacitance

80

100

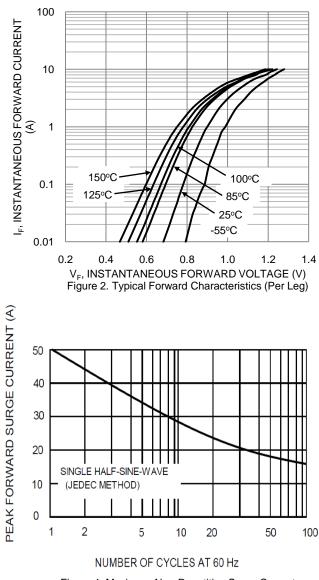


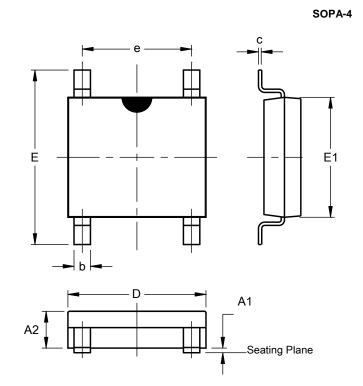
Figure 4. Maximum Non-Repetitive Surge Current

1 ^L 0



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

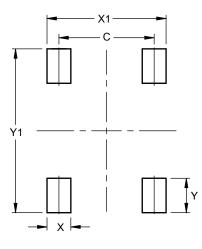


SOPA-4							
Dim	Min	Max	Тур				
A1		0.20					
A2	1.20	1.50					
b	0.50	0.70					
С	0.15	0.25					
D	4.80	5.30					
E	6.00	6.80					
E1	4.20	4.60					
е	3.80	4.20					
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOPA-4



Dimensions	Value (in mm)
С	4.00
Х	1.00
X1	5.00
Y	1.45
Y1	6.90



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